MULTI-INNO TECHNOLOGY CO., LTD.

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LCD MODULE SPECIFICATION

Model: MI0700SAT

For Customer's Acceptance:

Customer		
Approved		
Comment		

Revision	1.0
Engineering	
Date	2012-05-14
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2012-05-14	Final specification release	



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■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	7.0	Inch
Viewing direction	12:00	O' Clock
Gray scale inversion direction	6:00	O' Clock
$LCM(W \times H \times D)$	164.90×100.00×6.80	mm ³
Active area (W×H)	154.08×85.92	mm ²
Pixel pitch (W×H)	0.1926×0.179	mm ²
Number of dots	800 (RGB) × 480	/
Backlight type	24 LEDs	/
Interface type	RGB 24 bits with TCON	/
Color depth	16M	/
Pixel configuration	R.G.B vertical stripe	/
Surface treatment	Anti glare	/
Input voltage	3.3	V
With/Without TSP	With TSP	/
Weight	198	g

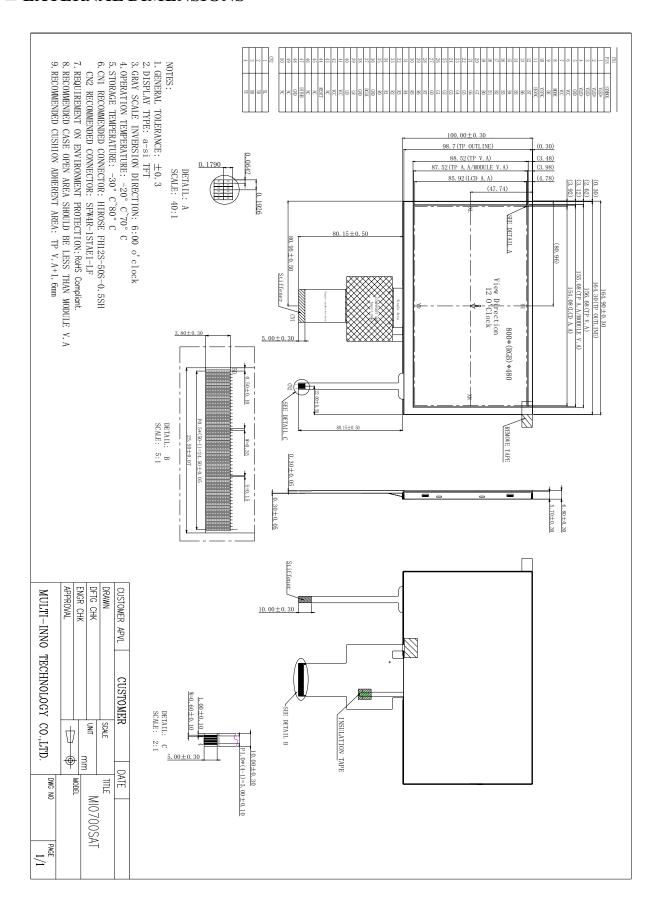
Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : RoHS compliant;

Note 3: LCM weight tolerance: ± 5%.



■ EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Power Voltage	VCC	-0.5	5	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Digital supply voltage	VCC	3.0	3.3	3.6	V
Input voltage 'H'level	VIH	0.7VCC	-	VCC	V
Input voltage 'L' level	VIL	0	-	0.3VCC	V
Current of supply voltage	Ivcc	-	-	150	mA

■ BACKLIGHT CHARACTERISTICS

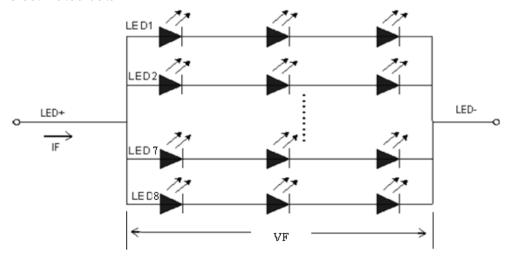
Ta=25°C

ltem	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I _F	-	160.0	-	mA	24 500
Forward Current Voltage	V_{F}	-	9.6	-	1 1/	24 LEDs (3 LED Serial, 8
Backlight Power Consumption	W _{BL}	-	1536	-	mW	LED Parallel)

Note1: The LED driving condition is defined for each LED module (3 LED Serial, 8 LED Parallel). For each LED: I_F (1/8) =20mA, V_F (1/3) =3.2V.

Note2: Under LCM operating, the stable forward current should be inputted. And forward voltage is for reference only.

Note3: I_F is defined for one channel LED.Optical performance should be evaluated at Ta=25 $^{\circ}$ C only If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced.Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.





■ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark	Note	
Response time	Tr +Tf		-	50	-	ms	Fig.1	4	
Contrastratio	Cr	θ=0°	400	500	-		FIG 2.	1	
Luminance uniformity	δ WHITE	Ø=0° Ta=25℃	-	75	-	%	FIG 2.	3	
Surface Luminance	Lv	1 a-25 C	250	280	-	cd/m ²	FIG 2.	2	
		Ø = 90°	50	60	-	deg	FIG 3.		
Viewing angle range	θ	Ø = 270°	60	70	-	deg	FIG 3.	6	
viewing angle range	в	Ð	Ø = 0°	60	70	-	deg	FIG 3.] "
		Ø = 180°	60	70	-	deg	FIG 3.		
	Red x		0.545	0.595	0.645				
	Red y		0.300	0.350	0.400				
	Green x	θ=0°	0.300	0.350	0.400				
CIE (x, y) chromaticity	Green y		0.525	0.575	0.625		FIG 2.	5	
	Blue x	Ø=0°	0.100	0.150	0.200		FIG 2.		
	Blue y	Ta=25℃	0.052	0.102	0.152				
	White x		0.270	0.320	0.370				
	White y		0.290	0.340	0.390				
NTSC Ratio	S		-	50	-	%			

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

Contrast Ratio = Average Surface Luminance with all white pixels (P₁,P₂, P₃,P₄, P₅)

Average Surface Luminance with all black pixels (P₁, P₂, P₃,P₄, P₅)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels $(P_1, P_2, P_3, P_4, P_5)$

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x,y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.



FIG.1. The definition of Response Time

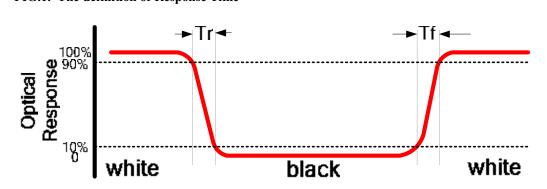


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A:5 mm

B:5 mm

H,V: Active Area

Light spot size \varnothing =5mm, 500mm distance from the

LCD surface to detector lens

measurement instrument is TOPCON's luminance

meter BM-5

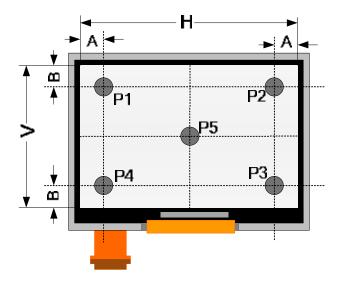
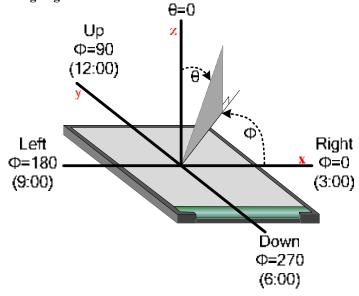


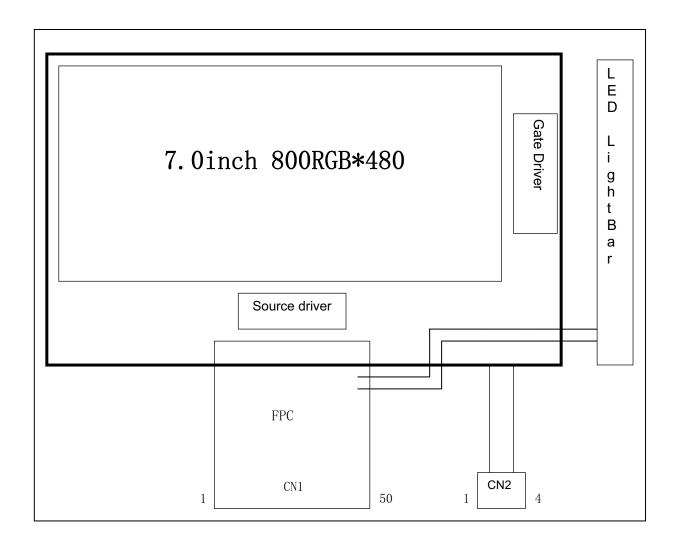
FIG.3. The definition of viewing angle





■ INTERFACE DESCRIPTION

1. Block Diagram





2 Input/Output Terminals

2.1 CN1 of FPC

PIN	Symbol	I/O	Description	Remark		
1	VLED+	Р	Led anode			
2	VLED+	Р	Led anode			
3	VLED-	Р	Led cathode			
4	VLED-	Р	Led cathode			
5	GND	Р	Ground			
6	VCC	Р	Digital power supply			
7	VCC	Р	Digital power supply			
8	MODE	1	DE/SYNC mode select. H:DE mode, L:SYNC mode			
9	DE	1	Data enable signal, active high to enable data			
10	VSYNC	I	Vertical sync input, negative polarity			
11	HSYNC	1	Horizontal sync input, negative polarity			
12	B7	1	Blue data (MSB)			
13	B6	ı	Blue data			
14	B5	I	Blue data			
15	B4	I	Blue data			
16	B3	I	Blue data			
17	B2	I	Blue data			
18	B1	I	Blue data			
19	В0	I	Blue data (LSB)			
20	G7	ı	Green data (MSB)			
21	G6	1	Green data			
22	G5	li	Green data			
23	G4	li	Green data			
24	G3	1	Green data			
25	G2	ı	Green data			
26	G1	ı	Green data			
27	G0	1	Green data (LSB)			
28	R7	l i	Red data (MSB)			
29	R6	i i	Red data			
30	R5	• 	Red data			
31	R4	i i	Red data			
32	R3	i i	Red data			
33	R2	i	Red data			
34	R1	i	Red data			
35	R0	i	Red data (LSB)			
36	GND	P	Ground			
37	DCLK	<u>'</u>	Clock for input data			
38	GND	P	Ground			
39	LR	l i	Source left or right sequence control			
40	UD	i i	Gate up or down scan control			
41	VCC	P	Digital power supply			
42	VCC	P	Digital power supply			
43	NC	NC	2.3.c. portor ouppry			



		ı .		
44	RESET	I	Global reset pin	
45	NC	NC		
46	NC	NC		
47	DITHB	I	Dithering setting. H: 6bit resolution, L: 8bit resolution	
48	GND	Р	Ground	
49	NC	NC		
50	NC	NC		

I---Input, O---Output, P--- Power/Ground

Table 2.1 terminal pin assignments

2.2 CN2 of TSP

PIN	Symbol	I/O Description		Remark
1	XL	O X+ channel output		
2	YD	0	Y+ channel output	
3	XR	0	X- channel output	
4	YU	0	Y- channel output	

I---Input, O---Output, P--- Power/Ground

Table 2.2 terminal pin assignments

2.3 U/D R/L Function Description

Scan co	Scan control input				
UD	LR	Scanning direction			
GND	VCC	Up to down, left to right			
VCC	GND	Down to up, right to left			
GND	GND	Up to down, right to left			
VCC	VCC	Down to up, left to right			

■ APPLICATION NOTES

1 Timing Chart

1.1 TCON (Embedded In Source IC) Input Timing (DCLK, HS, VS, DE)

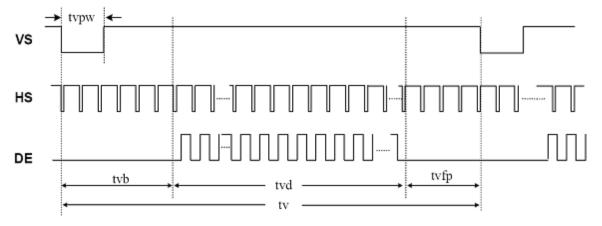
(VCC=3.3V, GND=0V, Ta=25°C)

Parameter	Symbol	Min	Тур	Max	Unit	Remark
DCLK	Fclk	-	30.0	_	MHZ	
DOLK	tclk	-	33.3	_	ns	
	th	-	1056	_	tclk	
	thd	-	800	_	tclk	
HS	thpw	1	-	40	tclk	
	thb	-	46	_	tclk	
	thfp	-	210	255	tclk	
	tv	513	525	600	th	
	tvd	-	480	_	th	
VS	tvpw	3	-	20	th	
	tvb	-	23	-	th	
	tvfp	-	22	-	th	

Note: 1.DE timing refer to HS, VS input timing.

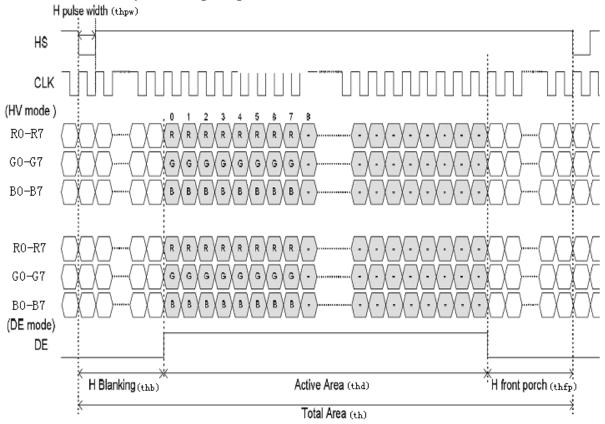
2.For internal GMA version IC.

TCON Vertical Input Timing Diagram HV





TCON Horizontal Input Timing Diagram

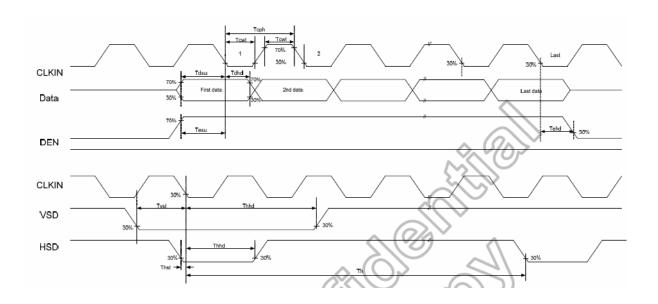


1.2 Input timing Characteristics of Interface(DCLK,VS,HS,DE)

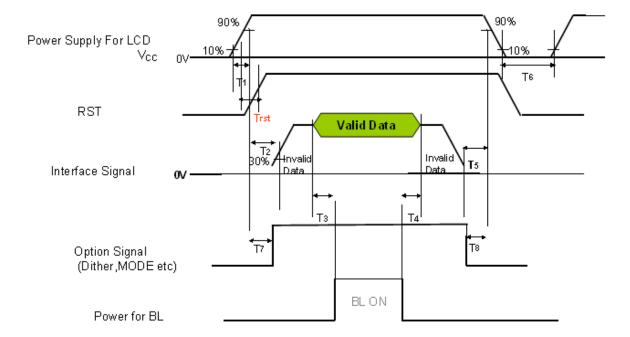
(VCC=3.3V, GND=0V, Ta=25°C)

Parameter	Symbol	Min	Тур	Max	Unit	Remark
DCLK frequency	Fclk	-	30.0	40.0	MHz	
DCLK cycle time	Tcph	-	33.3	25	ns	
DCLK pulse width	Tcw	40%	50%	60%	Tcph	
VS setup time	Tvst	8			ns	
VS hold time	Tvhd	8	-	-	ns	
HS setup time	Thst	8			ns	
HS hold time	Thhd	8	-	ı	ns	
Data setup time	Tdsu	8			ns	Data to DCLK
Data hold time	Tdhd	8	-	-	ns	Data to DCLK
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	





1.3 POWER ON/OFF SEQUENCE





Sequence table

0			Mata		
Parameter	Min	Typ	Na:	Unit	Notes
TI	0.5	•	20	uus	
T2	0.5		-	ms	
Т3	200		-	ms	
T4	200		-	ms	
T5	0	-	-	ma	
Т6	2.0		-	8	
Т7	0.6	-	T2	we	
Т9	0		-	ms	

Note:

- Please avoid floating state of interface signal at invalid period.
 Please avoid floating state of Option signal when power on.
- 3. Trest <1ms



■ RELIABILITY TEST

No.	Test Item	Test Condition	Remark
1	High Temperature Storage	80±2°C/240 hours	IEC60068-2-1:2007 GB2423.2-2008
2	Low Temperature Storage	-30±2°C/240 hours	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Operating	70±2℃/240 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Operating	-20±2°C/240 hours	IEC60068-2-1:2007 GB2423.1-2008
5	Temperature Cycle storage	$-30\pm2^{\circ} \sim 25\sim 80\pm2^{\circ} \times 100$ cycles (30min.) (5min.) (30min.)	Start with cold temperature, End with high temperature, IEC60068-2-14:1984, GB2423.22-2002
6	Damp proof Test operating	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH/240 hours}$	IEC60068-2-78 :2001 GB/T2423.3-2006
7	Vibration Test (non-operation)	Frequency range:10Hz~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X,Y,Z(6 hours for total)	IEC60068-2-6:1982 GB/T2423.10-1995
8	Package drop test	Height:60cm,1 corner,3 edges,6 surfaces	IEC60068-2-32
9	ESD test (operation)	HBM 15KV,5points, 5times/point (Environment:15°C ~35°C ,30%~60%. 86Kpa~106Kpa)	ul 991-2008 Section 15
10	Shock(non-operation)	Half sine wave:100G 6ms, ±X,±Y,±Z 3times each direction	IEC60068-2-27:1987 GB/T2423.5-1995

Note 1:Ts is the temperature of panel's surface. Note 2:Ta is the ambient temperature of sample.



■ INSPECTION CRITERION

MIF	OUTGOING QUALITY STANDARD	PAGE 1 OF 7
TITLE:FUNCTION	NAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch panel.

1 Sample plan

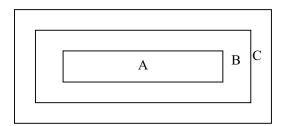
Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

4. Inspection standards

4.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	
4.1.2	Missing	Missing component	Major
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
4.1.4	linearity	No more than 1.5%	

4.2 Cosmetic Defect

Item No	Items to be inspected	Inspection Standard				Classification of defects
	Clear Spots Black and white Spot defect	For dark/white spot, as $\Phi = \frac{(x+y)}{2}$ 1. Zone		ined Acceptable Q	ty Dty	
	Pinhole,	Size(mm)	A	В	С	Minor
	Foreign	Ф≤0.1	Ign	ore		1122202
	Particle,	$0.10 < \Phi \le 0.15$		2	- Ignore	
	polarizer Dirt	$0.15 < \Phi \le 0.20$	1		Ignore	
4.2.1		0.20<Ф	C)		
		2.				
		Zone	F	Acceptable Q	Qty	
		Size(mm)	A	В	C	
	Clear Spots	Ф≤0.1	Ignore 3			N.
	TP Dirt	$0.10 < \Phi \le 0.15$			Ignore	Minor
		0.15< Φ≤0.25 2		Ignore 2		
		0.25<Ф	C)		





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TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

	3.				
Dim Snots	2. Zone		Acceptable Q	ty	
Dim Spots	Size(mm)	A	В	С	
Circle	Ф ≤ 0.2	Igı	nore		Minor
shaped and dim edged	0.20< Ф ≤ 0.40		2		
defects	0.40< Ф ≤ 0.60		1	- Ignore	
	0.60<Ф		0		

4.2 Cosmetic Defect

Item No	Items to be inspected		Inspection Standard Classification of defects							
		S	ize(mm)	A	Acceptable	Qty				
	Line defect	L(Length)	W(Width)		zone					
	Black line,	L(Length)	w (w idili)	A	В	С				
	White line, Foreign	Ignore	W≤0.02	Ig	nore					
	material on polarizer	L≤3.0	0.02 <w≤0.03< td=""><td></td><td>2</td><td></td><td></td></w≤0.03<>		2					
	P	L≤2.0	0.03 <w≤0.05< td=""><td></td><td>1</td><td>Ignore</td><td></td></w≤0.05<>		1	Ignore				
4.2.2					e as spot efect					
4.2.2		The line can be seen after mot condition:		obile phone in the operating			Minor			
		si	ze(mm)	A	cceptable (Qty				
	Foreign	I (I anoth)	W/(W/: 44h)		zone					
	material on TP film	L(Length)	W(Width)	A	В	С				
		Ignore	W≤0.03	Ignore						
				L≤5.0	0.03 <w≤ 0.05</w≤ 	3	3	Ignore		
			0.05 <w< td=""><td>Define as</td><td>spot defect</td><td></td><td></td></w<>	Define as	spot defect					
		assembling	If the scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 4.2.2.							
			The scratch can be seen only in non-operating condition or ome special angle, judge by the following.							





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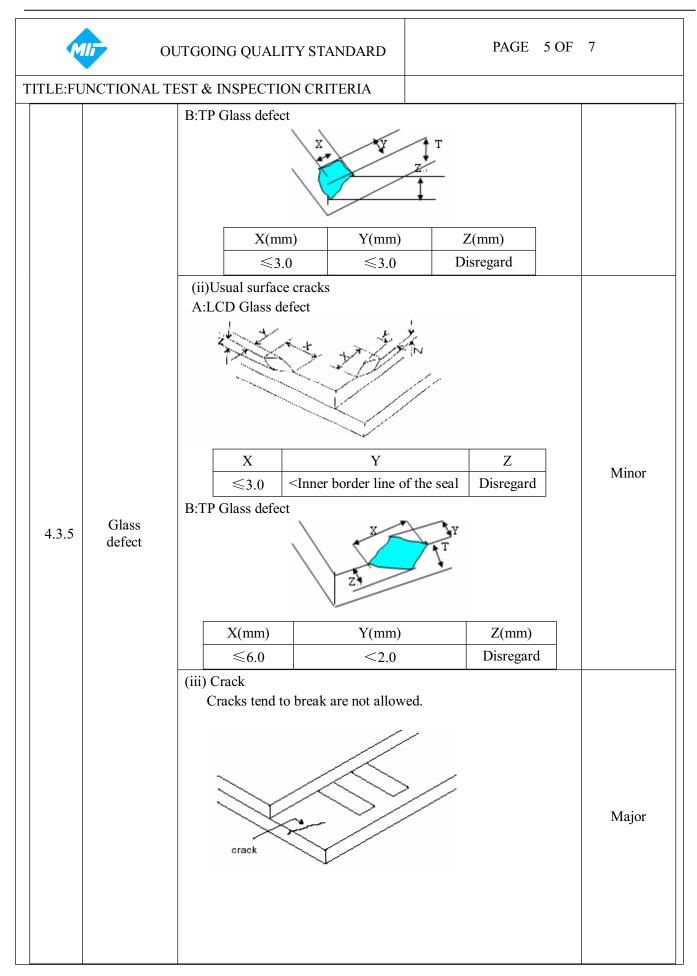
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

	Dim line	Size	e(mm)	Ac	cepta	ble Qty										
	defect	defect L(Length)			Zo	ne										
	Polarizer	L(Longth)	W(Width)	A	В	С										
4.2.3	scratch TP film	Ignore	W≤0.03	Igno	ore			Minor								
	scratch	5.0 <l≤10.0< td=""><td>0.03<w\le 0.05<="" td=""><td>2</td><td></td><td></td><td></td></w\le></td></l≤10.0<>	0.03 <w\le 0.05<="" td=""><td>2</td><td></td><td></td><td></td></w\le>	2												
										L≤5.0	0.05 <w≤0.08< td=""><td>1</td><td></td><td colspan="2">- Ignore</td><td></td></w≤0.08<>	1		- Ignore		
			0.08 <w< td=""><td>0</td><td></td><td></td><td></td><td></td></w<>	0												
		Air bubbles betw	reen glass & polariz	zer												
		2. Zone	Acc	cceptable Qty												
		Size(mm)	A	В		С										
4.2.4	Polarize Air bubble	Ф ≤ 0.2	Ignore	Ignore				Minor								
	111 00001	$0.20 < \Phi \leq 0.30$	2	2		Lamana										
		$0.30 < \Phi \leq 0.50$) 1			Ignore										
		0.50<Ф	0													

4.3. Cosmetic Defect

Item No	Items to be inspected	Iı	nspection Standar	d		Classification of defects
		(i) Chips on corner A:LCD Glass defect		•		Minor
		X	Y	Z		
		≤2.0	≤S	Disregard		
		Notes: S=contact pa Chips on the corner of te the ITO pad or expose pe	erminal shall not b	pe allowed to exte	nd into	











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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

4.4 Parts Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
	4.4.1 Parts contraposition	 Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. Not allow chip or solder component is off center more than 50% of the pad outline. 	Major
	4.4.2 SMT	According to the Acceptability of electronic assemblies>IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.	





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TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

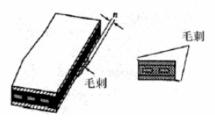
1. Pattern font:

Pattern fonts are clear and symmetrical, pattern fonts filter lightly are allowed; The fort line is not allow to thinner or thicker than 1/3of normal size, and swing is not more than 0.1mm. the line is smooth and not broken.



2. The wing forward in the side of Visual Area:

The length of wing forward inside of the Visual Area: $n \le 0.2$ mm; Not excess 3 point, and the distanceD ≥ 20 mm.



- 3. Film impression: With operation, must be invisibility.
- 4. Touch panel knob: if writing function normally,it could be allowed.

4.4.3 TP Defect



TP knob

5. Newton ring

Without operation, the color circle of Regularity or Non-regularity from the normal or slope angle of view.

- 1. **Regularity:** The area of the newton ring is less than 1/3 area of the touch panel; and no character affected and line distorted after touch panel lightening. It's ok.
- 2. **Non-regularity**: The area of the Newton ring is less than the 1/2 area of touch panel with lightening. And no character affected and line





Minor

■ PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling



and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

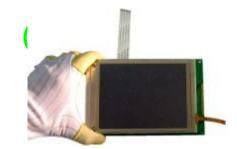
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.



2 Handling precaution for LCM

- 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
- 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others 其它

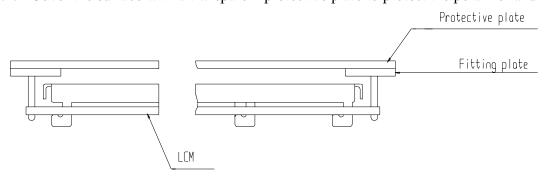
- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.

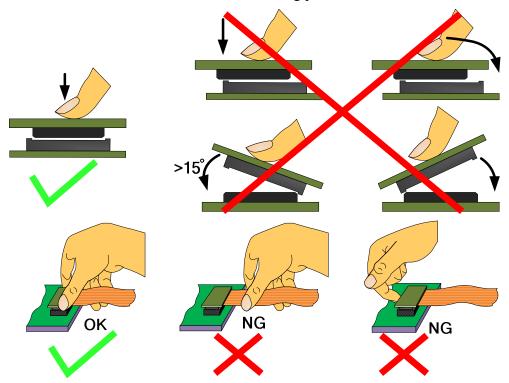


4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
			Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
		_	Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- If you have special requirement about reliability condition, please let us know before you start the test on our samples.